

## **Application Data Sheet**

### **Application Information**

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R??::

Number of CD disks::

Number of copies of CDs::

Sequence Submission::

Computer Readable Form (CRF)?::

Number of copies of CRF::

Title:: METHOD AND STRUCTURE FOR  
INTEGRATING METAL INSULATOR METAL  
CAPACITOR WITH COPPER

Attorney Docket Number:: 021653-001700US

Request for Early Publication:: No

Request for Non-Publication:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 8

Small Entity?:: No

Latin name::

Variety denomination name::

Petition included?:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers One::

Secrecy Order in Parent Appl.: No

**Applicant Information**

Applicant Authority Type: Inventor  
Primary Citizenship Country: Peoples Republic of China  
Status: Full Capacity  
Given Name: Zhen  
Middle Name:  
Family Name: Chen  
Name Suffix:  
City of Residence: Shanghai  
State or Province of Residence:  
Country of Residence: Peoples Republic of China  
Street of Mailing Address: 18 Zhang Jiang Rd.  
Postal Address Line Two: Pudong New Area  
City of Mailing Address: Shanghai  
State or Province of mailing address:  
Country of mailing address: Peoples Republic of China  
Postal or Zip Code of mailing address: 201203

Applicant Authority Type: Inventor  
Primary Citizenship Country: United Kingdom  
Status: Full Capacity  
Given Name: Wong  
Middle Name: Chen  
Family Name: Shih  
Name Suffix:  
City of Residence: Shanghai  
State or Province of Residence:  
Country of Residence: Peoples Republic of China  
Street of Mailing Address: 18 Zhang Jiang Rd.

Postal Address Line Two:: Pudong New Area  
City of Mailing Address:: Shanghai  
State or Province of mailing address::  
Country of mailing address:: Peoples Republic of China  
Postal or Zip Code of mailing address:: 201203

### **Correspondence Information**

Correspondence Customer Number:: 20350

### **Representative Information**

Representative Customer Number:: 20350

### **Domestic Priority Information**

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

### **Foreign Priority Information**

Country:: Application number:: Filing Date::  
People's Republic of China 200310122962.6 12/30/03

### **Assignee Information**

Assignee Name:: Semiconductor Manufacturing International  
(Shanghai) Corporation  
Street of mailing address:: 18 Zhang Jiang Road, Pudong New Area  
City of mailing address:: Shanghai  
State or Province of mailing address::  
Country of mailing address:: People's Republic of China  
Postal or Zip Code of mailing address:: 201203